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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







PRODUCT DATA SHEET



PhlatLight[™] SBT16 Projection Chipset

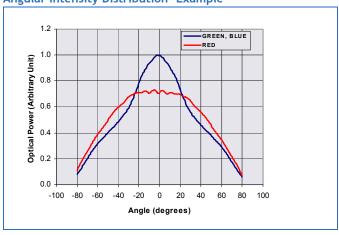


Luminus Devices' Projection Technology (PT) is an innovative solid-state light source created to replace arc lamps in projection systems, enabling a new category of lamp-free projectors. Enabled by unique use of Photonic Lattice technology, Phlat-Light chipsets represent a major breakthrough in brightness that delivers all the benefits of solid state light sources in projections applications:

- Wide color gamut for vivid colors, exceeds NTSC.
- Environmentally friendly technology Mercury-fre.
- Instant start and re-start no more wait time.
- High reliability; no more lamp replacement.
- Electronic control of color points and light intensity on a frame by frame basis

PhlatLight products benefit from numerous innovations in the domain of packaging, thermal management and optical coupling that allow designers to achieve efficient light engine designs and deliver high screen brightness.

Angular Intensity Distribution -Example



Features

- Matched RGB Chipset with 1.6mm² emitting area designed for small, pico projector and "value" pocket projector applications
- Photonic lattice technology for very high surface brightness
- Wide color gamut: RED 623 nm, GREEN 525 nm, BLUE 460 nm typical dominant wavelength
- Single emitting area per color allows for collection with single lens for simplified optics
- 16:10 aspect ratio optimized for WVGA, WXGA or other wide aspect ratio micro-displays
- Uniform surface emission
- Compact, small footprint surface mount (SMT) package, with built-in alignment features
- RoHS compliant (EU-2002/95/EC Directive)

Applications

- Large dynamic range allows optimum performance in both battery-powered and AC powered systems
- Optimized for Micro-Display diagonal sizes ranging from 0.2" to 0.4".
- Compatible with all micro-display technologies including $\mathsf{DLP}^{\mathsf{TM}}$ and $\mathsf{LCoS}.$





SBT-16 Ordering Part Numbers

Ordering Part Number ¹	Color	Min Flux or Power Bin ²	Availability	Description
SBT-16-R-J11-MPB	Pod	1A	Now	Red Bin Kit, PhlatLight SBT16 surface mount device consisting of a 1.6mm ²
SBT-16-R-J11-MPC	Red 1B		Now	LED, mounted on a ceramic substrate.
SBT-16-G-J11-MPA	1A		Now	
SBT-16-G-J11-MPB	Green	1B	Now	Green Bin Kit, PhlatLight SBT16 surface mount device consisting of a
SBT-16-G-J11-MPC	Green	1C	Now	1.6mm ² LED, mounted on a ceramic substrate
SBT-16-G-J11-MPD		1D	Now	
SBT-16-B-J11-EPA	Blue	1A	Now Blue Bin Kit, PhlatLight SBT16 surface mount device consisting	
SBT-16-B-J11-EPB		1B	Now	LED, mounted on a ceramic substrate

Note 1: Ordering part numbers represent bin kits (group of bins that are shippable for a given ordering part number)

Note 2: See Bin Kit and Flux / Power bin definitions on page 3

PhlatLight Ordering Part Number Nomenclature

SBT	-	NN	-	X	-	J11	-	XYZ	-	TR ¹
Product Family		Chip Area		Color		Package Configuration		Bin Kit ²		Packaging Op- tion
SBT: Surface mount SBR: SBT device sol- dered to a starboard		16: 1.6mm ²		R=Red G=Green B=Blue		J11: 9.0mm X 7.25mm		See page 3 for Bin Kit definition		TR= tape & reel blank=tray/pack

Note 1: For Tape and Reel Packaging option, please add -TR to end of ordering part number. E.g. SBT-16-R-J11-MPB-TR

Note 2: A Bin Kit represents a group of individual flux or power bins that are shippable for a given ordering part number.

In order to ensure availability, individual flux or power bins are not orderable.

EXAMPLES:

SBT-16-R-J11-MPB is comprised of Red Flux Bins 1A, 1B, 1C and 1D (Packaging option: trays / packs)

SBT-16-R-J11-MPB-TR is comprised of Red Flux Bins 1A, 1B, 1C and 1D (Packaging option: tape and reel)

SBR-16-R-J11-MPB is SBT-16 Red device soldered to a starboard (see p.10). Note: Available in sample quantities only for prototyping.





SBT-16 Bin Kit¹ and Flux / Power Bin^{2,3,4} Definitions

Note: Please refer to ordering part number table on page 2 for Bin Kit availability

Red Flux Bins	Bin 1A	Bin 1B	Bin 1C	Bin 1D	Bin 1E	Bin 1F	Bin 1G	Bin 1H	Bin 1J
Red Bin Flux Range (lm)	155-180	180-215	215-245	245-275	275-300	300-330	330-360	nd	nd
SBT-16-R-J11-MPB	Ø	Ø	Ø	Ø					
SBT-16-R-J11-MPC		Ø	Ø	\square	Ø				
Green Flux Bins	Bin 1A	Bin 1B	Bin 1C	Bin 1D	Bin 1E	Bin 1F	Bin 1G	Bin 1H	Bin 1J
Green Bin Flux Range (lm)	315-355	355-395	395-430	430-470	470-510	510-550	550-600	600-660	660-725
SBT-16-G-J11-MPA	Ø	Ø	Ø	Ø					
SBT-16-G-J11-MPB		Ø	Ø	Ø	Ø				
SBT-16-G-J11-MPC			Ø	Ø	Ø	Ø			
SBT-16-G-J11-MPD				Ø	Ø	Ø	Ø		
Blue Power Bins	Bin 1A	Bin 1B	Bin 1C	Bin 1D	Bin 1E	Bin 1F	Bin 1G	Bin 1H	Bin 1J
Blue Bin Power Range (W)	1.54-1.75	1.75-1.95	1.95-2.10	2.10-2.30	2.30-2.50	2.50-2.75	2.75-3.00	3.00-3.30	nd
SBT-16-B-J11-EPA	Ø	Ø	Ø	Ø	Ø				
SBT-16-B-J11-EPB		Ø	Ø	Ø	Ø	Ø			

Note 1: Bin Kits are defined by a group of flux or power bins. Only one flux bin will be shipped in each individual pack or reel. A shipment will contain packs or reels of different allowed flux or power bins for a particular ordering part number. In order to ensure availability, individual Flux or Power bins are not ordereable.

Note 2: Luminus maintains a tolerance of +/-6% on flux and power measurements

Note 3: SBT-16 LEDs are tested for luminous flux and radiometric at 4A, single pulse (20mS) and placed into one of the above flux or power bins. Flux and power bins have been defined, but not all defined bins are currently populated.

Note 4: Flux bin limits for Red and Green and power bin limits for Blue devices apply across the entire dominant wavelength range for each color. (See dominant wavelength range for each color on page 4)





Optical and Electrical Characteristics

		Symbol	Red	Green	Blue	Unit
Emitting Area			1.6	1.6	1.6	mm2
Emitting Area Dimensions			1.6x1.0	1.6x1.0	1.6x1.0	mmxmm
Characteristics at Test Drive Current, I_F	1					
Test Peak Drive Current ¹	typ	I _F	4.0	4.0	4.0	A
Peak Luminous Flux ^{1,2} , ³	typ	Ф۷	220	470	90	lm
Radiometric Flux ^{1, 2, 3}	typ	Фг	1.3	1.0	2.0	W
	min	λdmin	619	516	450	nm
Dominant Wavelength ¹	typ	λd	623	525	460	nm
	max	λdmax	630	535	468	nm
FWHM - Spectral bandwidth at 50% of Φν	typ	Δλd	18	40	20	nm
Chromaticity Coordinates ^{4,5}	typ	х	0.699	0.162	0.149	
chiomaticity coordinates	typ	у	0.301	0.711	0.031	
	min	V _{Fmin}	2.0	3.9	3.2	٧
Forward Voltage	typ	V _F	2.4	4.9	3.9	٧
	max	V _{Fmax}	3.2	5.9	5.2	٧
Dynamic Resistance	typ	Ω_{dyn}	0.08	0.09	0.07	Ω
Characteristics at Pulsed Drive Current,	I _F (for i	nformation o	only) ⁶			
Reference Duty Cycle			25	50	25	%
Reference Peak Drive Current	typ	I _F	4.0	4.0	4.0	А
Peak Luminuous Flux ²			215	400	80	lm
Device Thermal Characteristics			•	•		
Thermal Coefficient of Photometric Flux	typ		-1.1	-0.2	~0	% / °C
Thermal Coefficient of Radiometric Flux	typ		-0.6	-0.3	-0.1	% / °C
Forward Voltage Temperature Coefficient	typ		-3	-8	-4	mV / °C

Note 1: Test conditions: 4A, single pulse, 20ms, test temperature not controlled.

Note 2: Total flux from emitting area

Note 3: Luminus maintains a tolerance of +/-6% on flux and power measurements

Note 4: In CIE 1931 chromaticity diagram coodinates, normalized to X+Y+Z=1

Note 5: For reference only

Note 6: Typical performance based on SBT-16 mounted on Al coreboard. Operation at 720Hz, 4A, pulsed at the specified duty cycles and at constant heat sink temperature T_{hs} = 40°C. (See Thermal Resistance section for T_{hs} definition.)





Absolute Maximum Ratings

		Symbol	Red	Green	EP-Blue	Unit
Minimum Current (CW or Pulsed) ¹	Min		200	200	200	mA
Maximum Current (CW) ²	Max		2.4	2.4	2.4	Α
Maximum Current (pulsed) 1,3			4.8	4.8	4.8	Α
(t<= 2.5ms, frequency > 240Hz, duty cycle <60%)						
Absolute Maximum Junction Temperature ⁴	Max	T _{jmax}	110	150	150	°C
Storage Temperature Range			-40/+100	-40/+100	-40/+100	°C

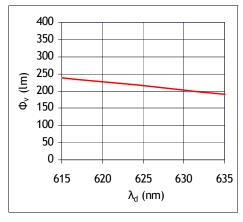
- Note 1: Product performance and lifetime data is specified at recommended forward drive currents. Sustained operation at or near absolute minimum currents may result in a reduction of device performance and device lifetime compared to recommended forward drive currents.
- Note 2: Luminus PhlatLight LEDs are designed for operation to an absolute maximum forward drive current density of 1.5A/mm² cw, and 3.0A/mm² pulsed (f>240Hz, duty cycle < 60%). Please refer to absolute maximum rating table above for specific absolute maximum currents for the products covered in this datasheet.

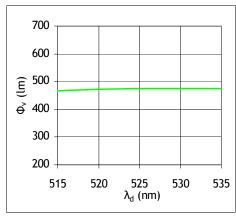
 Product lifetime data is specified at recommended forward drive currents. Sustained operation at absolute maximum currents will result in a reduction of device lifetime compared to recommended forward drive currents. Actual device lifetimes will also depend on junction temperature. Refer to the lifetime derating curves for further information.
- Note 3: In pulsed operation, rise time from 10 to 90% of forward current should be larger than 0.5 microseconds.
- Note 4: Sustained operation at or above the Absolute Maximum Junction Temperature (T_{imax}) will result in reduced device life time.

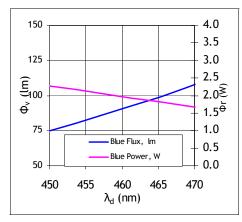




Luminous Flux variation with Wavelength: Φ_v = f (λ_d) at Test Drive Current I_F

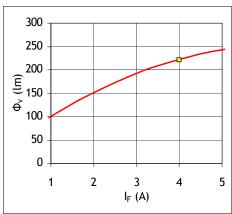


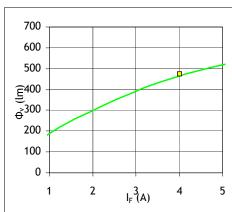


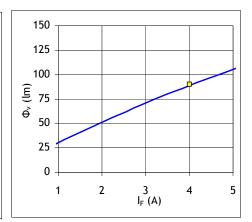


See note 1,3 on page 7.

Luminous Flux variation with Drive Current - $\Phi_{\rm V}$ = f (I_F) - Typical

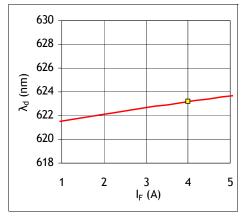


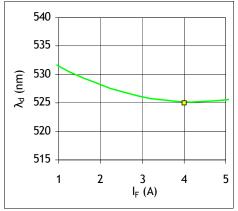


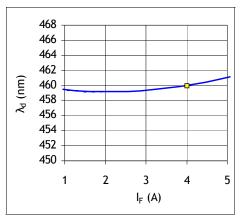


See notes 1, 2, 3 on page 7.

Dominant Wavelength variation with Forward Current - λ_d = $f(I_F)$ - Typical





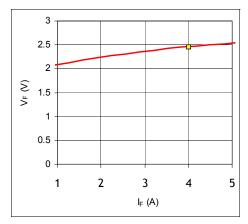


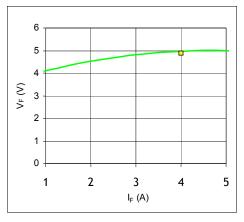
See notes 1, 2 on page 7.

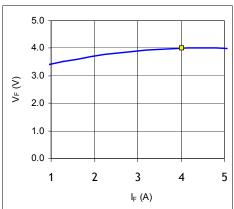




Forward Voltage variation with Drive current - $V_F = f(I_F)$ - Typical

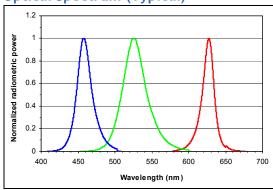






See notes 1,2 on page 7.

Optical Spectrum (Typical)



See note 4 on page 7.

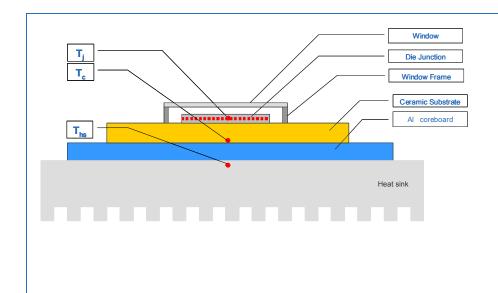
Chart Notes

- Note 1: Test conditions: single pulse, 20mS, test temperature not controlled. Data below 1.5A is extrapolated.
- Note 2: Yellow square indicate device operating point under test conditions: 4A, single 20mS pulse, test temperature not controlled
- Note 3: Luminus maintains a tolerance of +/-6% on flux and power measurements.
- Note 4: Typical Spectrum at recommended peak drive current.





Thermal Resistance



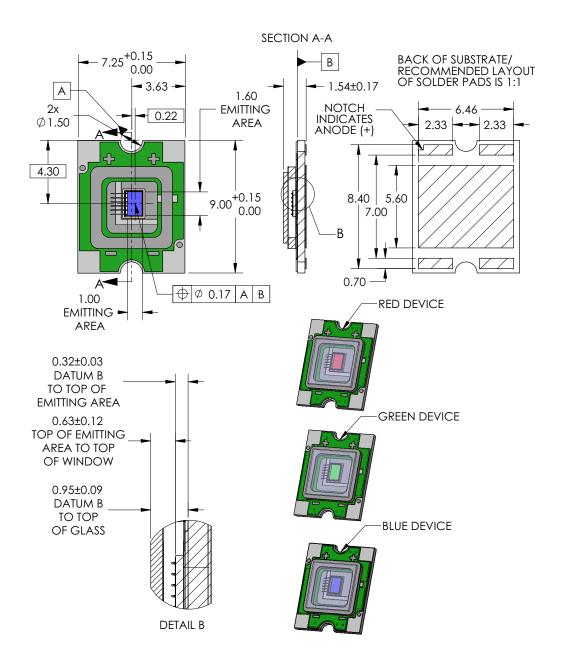
R_{j-c}^{-1}	6.0 °C/W
Rj-hs ²	7.4 °C/W

Note 1: Thermal resistance values are based on finite element analysis model results

Note 2: For information only.
Thermal resistance is
measured using a
SAC305 solder, an Alclad MCPCB (Bergquist
p/n 803949-1), and
eGraf 1205 thermal
interface material.



Mechanical Dimensions



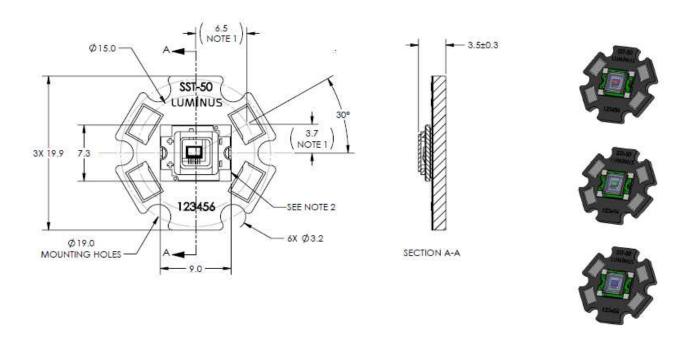
• Red, Green and Blue SBT16 PhlatLight TM LEDs are individually assembled into a SMT Board with a footprint of 9.0 mm x 7.25 mm.

Dimension above for information only. For detailed dimensions, always refer to the latest revision of the DWG-1493 package outline





Mechanical Dimensions - SBT-16 Star



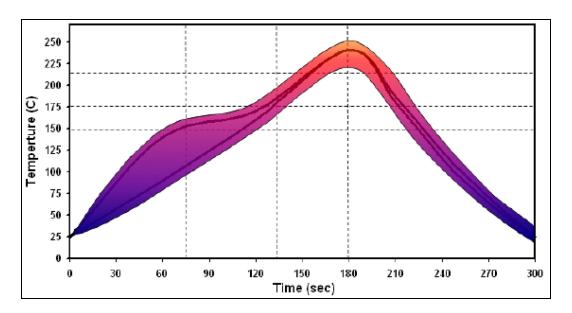
Notes:

- 1. Tolerances per IPC-610, Class 2.
- 2. For detail drawing of SBT-16, please see DWG 1493.
- 3. Recommended mounting screw: M3 or #4
- 4. All dimensions in millimeters
- 5. All anode pads on board are interconnected. All cathode pads on board are interconnected





Reflow Soldering Characteristics



Solder profile guideline

Solder Profile Stage	Lead-free solder	Lead-based solder
Profile Length, Ambient to Peak	2.75 - 3.5 minutes	2.75 - 3.5 minutes
Time Maintained Above: Temperature	217 °C	183 ℃
Time Maintained Above: Time	30 - 60 seconds	30-60 seconds
Cooldown Rate	≤ 4° C/sec	≤ 4° C/sec
Cooldown Duration	45 ± 15 sec	45 ± 15 sec

Note: 1. Temperatures are taken and monitored at the component copper layer

Note: 2. Optimum profile may differ due to oven type, circuit board or assembly layout

Note: 3. Recommended lead free, no-clean solder: AIM NC254-SAC305

Note: 4. Refer to APN-001473: PhlatLight Soldering and Handling application note for additional solder profiles and details.

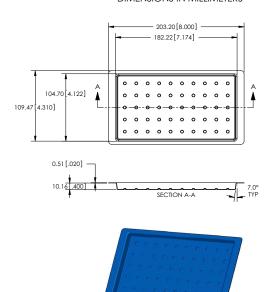




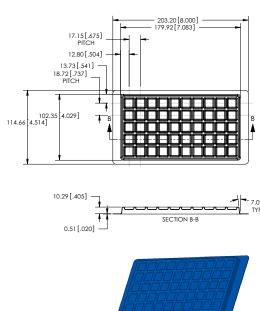
Shipping Tray Outline

For detailed drawing of shipping tray, please refer to TO-0977 and TO-0978 document (available from Luminus)

DIMENSIONS IN MILLIMETERS



DIMENSIONS IN MILLIMETERS





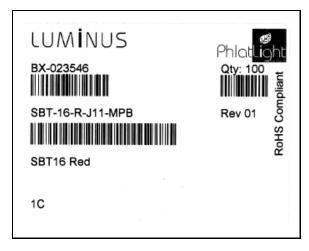


Tray Packing Configuration

Pack

Packing Case	Qty/Pack	Dimensions (WxLxH, mm)	Gross Weight (g)		
Pack	100	120 x 200 x 15	101		
(Stack of 2 Trays with 50 devices each)					
(Pack is enclosed in moisture barrier bag)					

Labeling Specification (example)



Sample labels - For illustration only

Pack Label Fields:

(Label fields are subject to change)

- •6-digitPackNumber: (Luminus Internal Use)
- •Luminus Ordering Part Number
- •Luminus_Product_Description: (Device Type and Color)
- •Quantity of devices in the pack
- Part Number Revision: (Luminus Internal Use)
- •Optional Fields may include Customer's Part Number

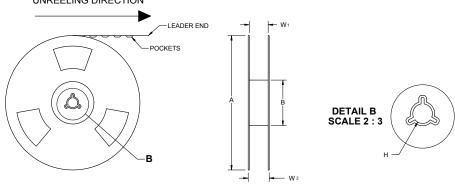




Tape and Reel Outline

For detailed drawing of Tape and Reel, please refer to TO-1000 (available from Luminus)

DIMENSIONS ARE IN mm. (INCH)) • • TRAILER 304.8 mm (19 POCKETS) OF + EMPTY POCKETS LEADER 457.2mm (29 POCKETS) OF EMPTY POCKETS LOADED POCKETS (250 PCS) DETAIL A SCALE 1:1 UNREELING DIRECTION TAPE DIMENSIONS W D В Е F Α С 24.0 (.945) Ø1.5 (.059) 3.9 (.157) 6.1 (.241) 1.7 (.069) 11.5 (.453) 16.0 (.630) **UNREELING DIRECTION** LEADER END -POCKETS



REEL DIMENSIONS

Α	W ₁	W ₂	В	Н	
Ø180 (7)	25 (.984)	27.8 (1.094)	60.0 (2.362)	Ø13.0 (.512)	





Packing Configuration

Tape and Reel

Packing Reel	Qty/Reel	Reel Diameter (mm)	Gross Weight (kg)
Tape and Reel	250	180	ТВА
(Reel is enclosed in moisture barrier bag)			

Labeling Specification (TBD)

Sample label - Illustration					

Tape and Reel Label Fields:

(Label fields are subject to change)

- •6-digit BX-Number:(Luminus Internal Use)
- •Luminus Ordering Part Number
- •Flux Bin
- •Quantity of devices in the pack
- •Optional Fields may include Customer's Part Number

Sample labels - For illustration only





History of Changes

Rev	Date	Description of Change
Rev 01	3/19/10	Preliminary Specifications
Rev 02	6/25/10	Add preliminary specifications for Green LED Binkit C Update Max Junction Temperature for Green and Blue devices Update Tray packing specifications
Rev 03	11/08/10	Add Bin Kit and Bin definitions (p.3) Add ordering part number information
Rev 04	04/12/11 5/17/11	Add additional Bin Kit definitions Update luminous flux and optical power specifications per test calibration update Add preliminary Tape and Reel packaging specifications Correct typographical error on p.2

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